### **ABSOLUTE MAXIMUM RATINGS**

(All voltages referenced to GND,	unless otherwise noted.)
V <sub>CC</sub>	0.3V to +6V
V <sub>EE</sub>	6V to +0.3V
Supply Voltage (VCC to VEE)	+12V
REFVOUT	
OSADJ, SCALE, REFISET	(V <sub>EE</sub> - 0.3V) to +5.5V
REFIIN, LOGIIN	
LOGV1, LOGV2, CMVOUT,	, ,
REFIOUT	$(V_{EE} - 0.3V)$ to $(V_{CC} + 0.3V)$
CMVIN	

Continuous Current (REFIIN, LOGIIN)	10mA
Continuous Power Dissipation ( $T_A = +70^{\circ}C$ )	
16-Pin Thin QFN (derate 16.9mW/°C above +70°C)	1349mW
Operating Temperature Range40°C	C to +85°C
Junction Temperature	+150°C
Storage Temperature Range65°C	
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### DC ELECTRICAL CHARACTERISTICS—Dual-Supply Operation

 $(V_{CC} = +5V, V_{EE} = -5V, GND = 0, I_{REF} = 1\mu A, I_{LOG} = 10\mu A, LOGV2 = SCALE, LOGV1 = OSADJ, CMVIN = CMVOUT, R_{SET} > 1M\Omega, T_A = -40^{\circ}C$  to +85°C. Typical values are at  $T_A = +25^{\circ}C$ , unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
Cupply Voltage	V <sub>CC</sub>	(Note 2)		2.7		5.5	V
Supply Voltage	VEE	(Note 2)		-2.7		-5.5	]
Cupply Current	loo	$T_A = +25^{\circ}C$			5	6	mA
Supply Current	Icc	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$			7.5	MA	
LOGIIN Current Range	lugg	Minimum		10			nA
(Notes 3, 4)	llog	Maximum				1	mA
REFIIN Current Range	loss	Minimum		10			nA
(Notes 3, 4)	I <sub>REF</sub>	Maximum				1	mA
Common-Mode Voltage	Vсмvоит						V
Common-Mode Voltage Input Range	VCMVIN			0		0.5	V
	V <sub>LC</sub>	I <sub>REF</sub> = 10nA, I <sub>LOG</sub> = 10nA to 1mA,	T <sub>A</sub> = +25°C		±2	±5	mV
Log Conformity Error	VLC	K = -0.25V/decade (Note 4)	$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$			±10	IIIV
Lagarithusia Clara (Caala Fastar)	I/	T <sub>A</sub> = +25°C		-237.5	-250	-262.5	mV/
Logarithmic Slope (Scale Factor)	K	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		-231.25		-268.75	decade
Logarithmic Slope (Scale Factor) Temperature Drift		$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$	$T_A = -40$ °C to $+85$ °C		80		μV/ decade/ °C
Input Offset Voltage	V <sub>IO</sub>	T <sub>A</sub> = +25°C, IV <sub>CMVIN</sub> IV <sub>CMVIN</sub> - V <sub>LOGIIN</sub> I		0.6	5	mV	
Input Offset Voltage Temperature Drift	V <sub>IOS</sub>	IV <sub>CMVIN</sub> - V <sub>REFIIN</sub> I, IV <sub>0</sub>		6		μV/°C	
Voltage Reference Output	\/pen/01:7	T <sub>A</sub> = +25°C		1.218	1.238	1.258	V
Voltage Reference Output	VREFVOUT	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	(Note 4)	1.195		1.275	\ \ \

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### DC ELECTRICAL CHARACTERISTICS—Dual-Supply Operation (continued)

 $(V_{CC} = +5V, V_{EE} = -5V, GND = 0, I_{REF} = 1\mu A, I_{LOG} = 10\mu A, LOGV2 = SCALE, LOGV1 = OSADJ, CMVIN = CMVOUT, R_{SET} > 1M\Omega, T_A = -40^{\circ}C$  to  $+85^{\circ}C$ . Typical values are at  $T_A = +25^{\circ}C$ , unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Voltage Reference Output Current	IREFVOUT			1		mA
Current Reference Output	\/	T <sub>A</sub> = +25°C	490	500	510	ma\ /
Voltage	VREFISET	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C \text{ (Note 4)}$	482		518	mV
LOGV2 BUFFER						
land the Office Weltonia	V	T <sub>A</sub> = +25°C		0.4	2	ma\ /
Input Offset Voltage	V <sub>IO</sub>	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C \text{ (Note 4)}$			6	mV
Input Bias Current	IB	(Note 4)		0.01	1	nA
Outrout Valtage Dange	Voh	$R_L$ to GND = $2k\Omega$		V <sub>CC</sub> - 0.2	V <sub>CC</sub> - 0.3	V
Output Voltage Range	VoL	$R_L$ to GND = $2k\Omega$	V <sub>EE</sub> + 0.2	VEE + 0.08		V
Outrout Chart Circuit Courset	I <sub>OUT+</sub>	Sourcing		34		A
Output Short-Circuit Current	IOUT-	Sinking		58		mA
Slew Rate	SR			12		V/µs
Unity-Gain Bandwidth	GBW			5		MHz

### AC ELECTRICAL CHARACTERISTICS—Dual-Supply Operation

 $(V_{CC} = +5V, V_{EE} = -5V, GND = 0, I_{REF} = 1\mu A, I_{LOG} = 10\mu A, LOGV2 = SCALE, LOGV1 = OSADJ, CMVIN = CMVOUT, R_{SET} > 1M\Omega, T_A = +25^{\circ}C, unless otherwise noted.)$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
LOGV2 Total Noise		0.1Hz to 10Hz, total output-referred noise, IREF = 10nA, ILOG = 100nA		17		μV <sub>RMS</sub>
LOGV2 Spot Noise Density		$f = 5kHz$ , $I_{REF} = 10nA$ , $I_{LOG} = 100nA$		0.8		μV/√Hz
REFVOUT Total Noise		1Hz to 10Hz, total output-referred noise		3.3		μV <sub>RMS</sub>
REFVOUT Spot Noise Density		f = 5kHz		266		nV/√Hz
REFISET Total Noise		1Hz to 10Hz, total output-referred noise		0.67		μV <sub>RMS</sub>
REFISET Spot Noise Density		f = 5kHz		23		nV/√Hz
Small-Signal Unity-Gain Bandwidth		$I_{REF}$ = 1μA, $I_{LOG}$ = 10μA, $R_{COMP}$ = 300 $\Omega$ , $C_{COMP}$ = 32pF		1		MHz

Note 1: All devices are 100% production tested at  $T_A = +25^{\circ}C$ . All temperature limits are guaranteed by design.

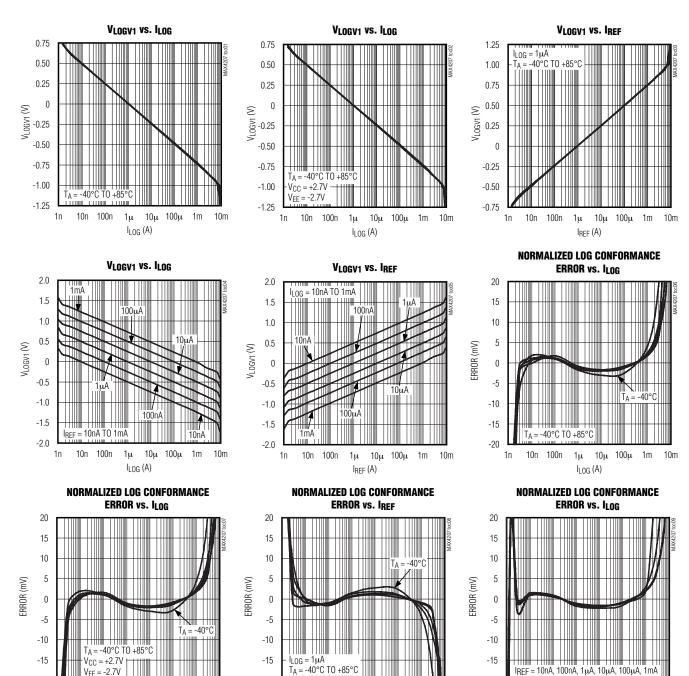
Note 2: Guaranteed and functionally verified.

**Note 3:** Log conformity error less than  $\pm 5$ mV with scale factor = 0.25V/decade.

Note 4: Guaranteed by design.

### **Typical Operating Characteristics**

 $(V_{CC} = +5V, V_{EE} = -5V, GND = 0V, I_{REF} = 1\mu A, I_{LOG} = 10\mu A, LOGV2 = SCALE, LOGV1 = OSADJ, CMVIN = CMVOUT, R_{SET} > 1M\Omega, T_A = +25^{\circ}C$ , unless otherwise noted.)



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1μ 10 I<sub>REF</sub> (A)

 $10\mu$   $100\mu$  1m 10m

10n 100n

-20

10n 100n

1μ 10μ 100μ 1m 10m

 $I_{LOG}\left(A\right)$ 

-20

-20

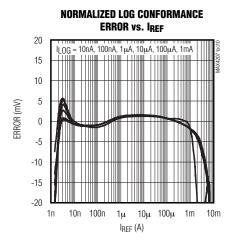
10n 100n

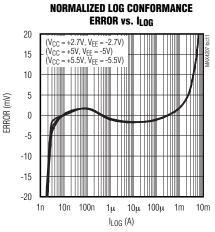
10μ

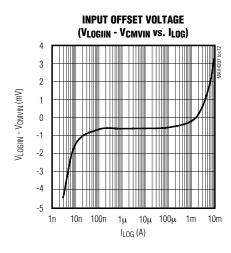
ILOG (A)

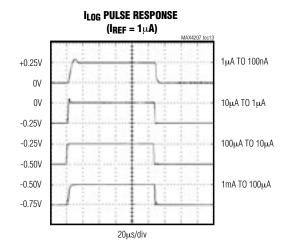
### Typical Operating Characteristics (continued)

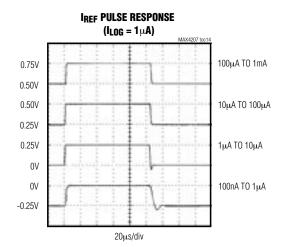
 $(V_{CC} = +5V, V_{EE} = -5V, GND = 0V, I_{REF} = 1\mu A, I_{LOG} = 10\mu A, LOGV2 = SCALE, LOGV1 = OSADJ, CMVIN = CMVOUT, R_{SET} > 1M\Omega, T_A = +25^{\circ}C, unless otherwise noted.)$ 





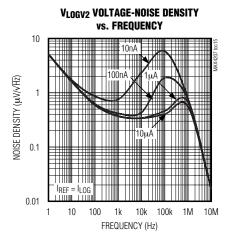


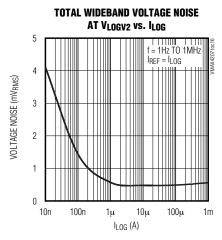


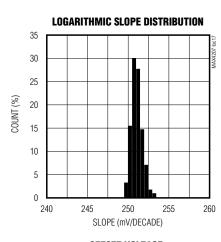


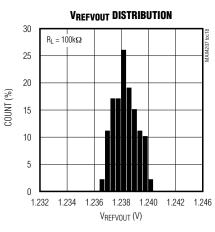
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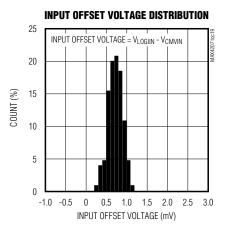
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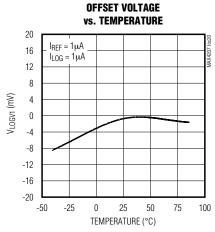


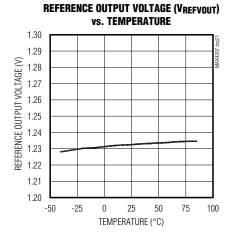


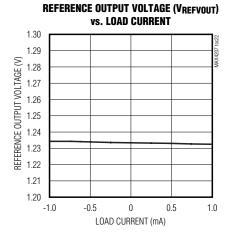






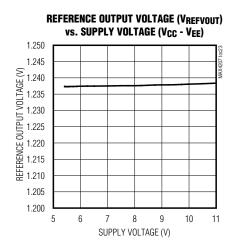


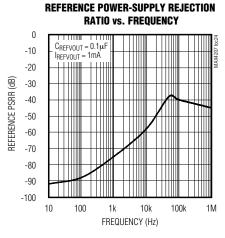


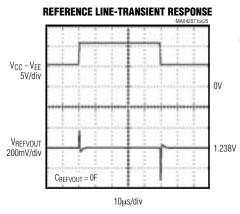


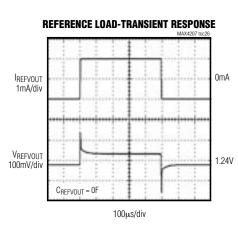
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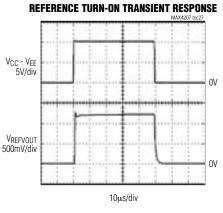
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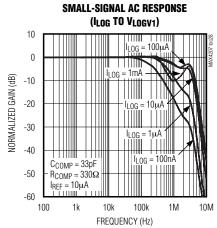


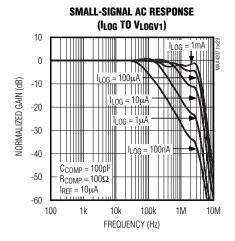


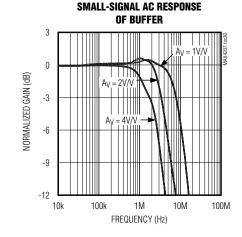












MIXIM

### **Pin Description**

PIN	NAME	FUNCTION
1, 9	N.C.	No Connection. Not internally connected.
2	REFVOUT	1.238V Reference Voltage Output. Bypass REFVOUT to GND with a 0 to 1µF capacitor (optional).
3	GND	Ground
4	V <sub>EE</sub>	Negative Power Supply. Bypass V <sub>EE</sub> to GND with a 0.1µF capacitor.
5	LOGV1	Logarithmic Amplifier Voltage Output 1. The output scale factor of LOGV1 is -0.25V/decade.
6	OSADJ	Offset Adjust Input. Apply a voltage at OSADJ to adjust the LOGV2 output offset voltage (see the <i>Output Offset</i> section).
7	SCALE	Scale Factor Input. Adjust the output scale factor for LOGV2 using a resistive divider (see the <i>Scale Factor</i> section).
8	LOGV2	Logarithmic Amplifier Voltage Output 2. Adjust the output scale factor for LOGV2 using a resistive divider between SCALE, GND, and LOGV2 (see the <i>Scale Factor</i> section).
10	Vcc	Positive Power Supply. Bypass V <sub>CC</sub> to GND with a 0.1µF capacitor.
11	REFISET	Current Reference Adjust Input. A resistor (R <sub>SET</sub> ), from REFISET to GND, adjusts the current at REFIOUT (see the <i>Adjusting the Logarithmic Intercept</i> section).
12	CMVOUT	0V Common-Mode Voltage Reference Output
13	REFIOUT	Current Reference Output. The internal current reference output is available at REFIOUT.
14	REFIIN	Current Reference Input. Apply an external reference current at REFIIN. IREFIIN is the reference current used by the logarithmic amplifier when generating LOGV1.
15	LOGIIN	Current Input to Logarithmic Amplifier. LOGIIN is typically connected to a photodiode anode or other external current source.
16	CMVIN	Common-Mode Voltage Input. V <sub>CMVIN</sub> is the common-mode voltage for the input and reference amplifiers (see the <i>Common Mode</i> section).

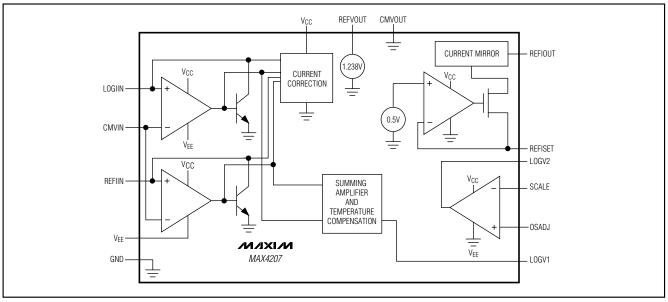


Figure 1. Functional Diagram

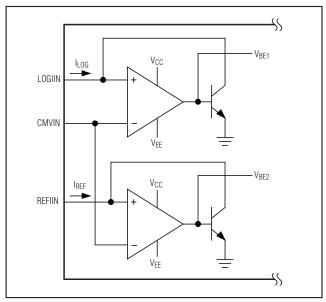


Figure 2. Simplified Model of a Logarithmic Amplifier

### **Detailed Description**

#### Theory

Figure 2 shows a simplified model of a logarithmic amplifier. Two transistors convert the currents applied at LOGIIN and REFIIN to logarithmic voltages according to the following equation:

$$V_{BE} = \left(\frac{kT}{q}\right) \ln \left(\frac{I_C}{I_S}\right)$$

where:

V<sub>BE</sub> = base-emitter voltage of a bipolar transistor

 $k = 1.381 \times 10^{-23} \text{ J/K}$ 

T = absolute temperature (K)

 $q = 1.602 \times 10^{-19} C$ 

IC = collector current

Is = reverse saturation current

The logarithmic amplifier compares  $V_{BE1}$  to the reference voltage  $V_{BE2}$ , which is a logarithmic voltage for a known reference current, IREF. The temperature dependencies of a logarithmic amplifier relate to the thermal voltage, (kT/q), and Is. Matched transistors eliminate the Is temperature dependence of the amplifier in the following manner:

$$\begin{split} &V_{OUT} = V_{BE1} - V_{BE2} \\ &= \left(\frac{kT}{q}\right) ln \left[ \left(\frac{l_{LOG}}{l_{S}}\right) - \left(\frac{kT}{q}\right) ln \left(\frac{l_{REF}}{l_{S}}\right) \right] \\ &= \left(\frac{kT}{q}\right) \left[ ln \left(\frac{l_{LOG}}{l_{S}}\right) - ln \left(\frac{l_{REF}}{l_{S}}\right) \right] \\ &= \left(\frac{kT}{q}\right) \left[ ln \left(\frac{l_{LOG}}{l_{REF}}\right) \right] \\ &= \left(\frac{kT}{q}\right) \left( ln(10) \right) \left[ log_{10} \left(\frac{l_{LOG}}{l_{REF}}\right) \right] \\ &= K \times log_{10} \left(\frac{l_{LOG}}{l_{REF}}\right) \end{split} \tag{see Figure 3}$$

where:

k = scale factor (V/decade)

ILOG = the input current at LOGIIN

IREF = the reference current at REFIIN

The MAX4207 uses internal temperature compensation to virtually eliminate the effects of the thermal voltage, (kT/q), on the amplifier's scale factor, maintaining a constant slope over temperature.

#### **Definitions**

#### **Transfer Function**

The ideal logarithmic amplifier transfer function is:

$$V_{IDEAL} = K \times log_{10} \left( \frac{I_{LOG}}{I_{REF}} \right)$$

Adjust K (see the *Scale Factor* section) to increase the transfer-function slope as illustrated in Figure 3. Adjust IREF using REFISET (see the *Adjusting the Logarithmic Intercept* section) to shift the logarithmic intercept to the left or right as illustrated in Figure 4.

#### Log Conformity

Log conformity is the maximum deviation of the MAX4207's output from the best-fit straight line of the V<sub>LOGV1</sub> versus log (I<sub>LOG</sub>/I<sub>REF</sub>) curve. It is expressed as a percent of the full-scale output or an output voltage.

#### Referred-to-Input and Referred-to-Output Errors

The log nature of the MAX4207 insures that any additive error at LOGV1 corresponds to multiplicative error at the input, regardless of input level.

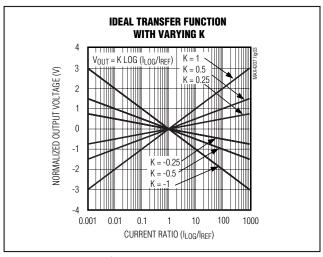


Figure 3. Ideal Transfer Function with Varying K

#### Total Error

Total error (TE) is defined as the deviation of the output voltage,  $V_{LOGV1}$ , from the ideal transfer function (see the *Transfer Function* section):

$$V_{LOGV1} = V_{IDEAL} \pm TE$$

TE is a combination of the associated gain, input offset current, input bias current, output offset voltage, and transfer characteristic nonlinearity (log conformity) errors:

$$V_{LOGV2} = K(1 \pm \Delta K) \left[ log_{10} \left( \frac{l_{LOG} - l_{BIAS1}}{l_{REF} - l_{BIAS2}} \right) \pm 4 \left( \pm V_{LC} \pm V_{OSOUT} \right) \right]$$

where V<sub>LC</sub> and V<sub>OSOUT</sub> are the log conformity and output offset voltages, respectively. Output offset is defined as the offset occurring at the output of the MAX4207 when equal currents are presented to I<sub>LOG</sub> and I<sub>REF</sub>. Because the MAX4207 is configured with a gain of K = -0.25V/decade, a 4 should multiply the ( $\pm$ V<sub>LC</sub>  $\pm$ V<sub>OSOUT</sub>) term, if V<sub>LC</sub> and V<sub>OSOUT</sub> were derived from this default configuration.

 ${\sf IBIAS1}$  and  ${\sf IBIAS2}$  are currents in the order of 20pA, significantly smaller than  ${\sf ILOG}$  and  ${\sf IREF}$ , and can therefore be eliminated:

$$V_{\text{LOGV2}} \cong K(1 \pm \Delta K) \left\lceil \log_{10} \left( \frac{I_{\text{LOG}}}{I_{\text{REF}}} \right) \pm 4 \left( \pm V_{\text{LC}} \pm V_{\text{OSOUT}} \right) \right\rceil$$

Expanding this expression:

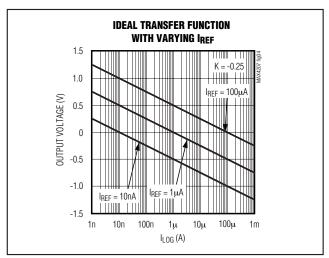


Figure 4. Ideal Transfer Function with Varying IREF

$$\begin{split} V_{LOGV2} &\cong K log_{10} \bigg( \frac{l_{LOG}}{l_{REF}} \bigg) \pm K \Delta K log_{10} \bigg( \frac{l_{LOG}}{l_{REF}} \bigg) \\ &\pm 4 K (1 + \Delta K) \big( \pm V_{LC} \pm V_{OSOUT} \big) \end{split}$$

The first term of this expression is the ideal component of  $V_{LOGV1}$ . The remainder of the expression is the TE:

$$TE \cong \pm K\Delta K \log_{10} \left( \frac{I_{LOG}}{I_{REF}} \right) \pm 4K(1 + \Delta K) \left( \pm V_{LC} \pm V_{OSOUT} \right)$$

In the second term, one can generally remove the products relating to  $\Delta K,$  because  $\Delta K$  is generally much less than 1. Hence, a good approximation for TE is given by:

$$TE \cong \pm K \left[ \Delta K \log_{10} \left( \frac{I_{LOG}}{I_{REF}} \right) \pm 4 \left( \pm V_{LC} \pm V_{OSOUT} \right) \right]$$

As an example, consider the following situation:

Full-scale input = 5V

 $I_{LOG} = 100 \mu A$ 

IRFF = 100nA

 $K = 1 \pm 5\%$  V/decade (note that the uncommitted amplifier is configured for a gain of 4)

 $V_{LC} = \pm 5mV$  (obtained from the *Electrical Characteristics* table)

 $VOSOUT = \pm 2mV$  (typ), and TA = +25°C.

Substituting into the TE approximation,

TE  $\approx \pm (1\text{V/decade})(0.05 \log_{10} (100\mu\text{A}/100\text{nA}) \pm 4 (\pm 5\text{mV} \pm 2\text{mV}) = \pm [0.15\text{V} \pm 4(\pm 7\text{mV})]$ 

As a worst case, one finds TE  $\approx \pm 178$ mV or  $\pm 3.6\%$  of full scale.

When expressed as a voltage, TE increases in proportion with an increase in gain as the contributing errors are defined at a specific gain. Calibration using a look-up table eliminates the effects of gain and output offset errors, leaving conformity error as the only factor contributing to total error. For further accuracy, consider temperature monitoring as part of the calibration process.

### \_Applications Information

### **Input Current Range**

Five decades of input current across a 10nA to 1mA range are acceptable for I<sub>LOG</sub> and I<sub>REF</sub>. The effects of bias currents increase as I<sub>LOG</sub> and I<sub>REF</sub> fall below 10nA. Bandwidth decreases at low I<sub>LOG</sub> values (see the *Frequency Response and Noise Considerations* section). As I<sub>LOG</sub> and I<sub>REF</sub> increase to 1mA or higher, transistors become less logarithmic in nature. The MAX4207 incorporates leakage current compensation and high-current correction circuits to compensate for these errors.

### **Frequency Compensation**

The MAX4207's frequency response is a function of the input current magnitude and the selected compensation network at LOGIIN and REFIIN. The compensation network comprised of CCOMP and RCOMP ensures stability over the specified range of input currents by introducing an additional pole/zero to the system. For the typical application, select CCOMP = 32pF and  $RCOMP = 330\Omega$ .

### Frequency Response and Noise Considerations

The MAX4207 bandwidth is proportional to the magnitude of the IREF and ILOG currents, whereas the noise is inversely proportional to IREF and ILOG currents.

### **Common Mode**

A 0V common-mode input voltage, V<sub>CMVOUT</sub>, is available at CMVOUT and can be used to bias the logging and reference amplifier inputs by connecting CMVOUT to CMVIN. A voltage between 0 and 0.5V, connected to CMVIN, may be used to bias the logging and reference transistor collectors, thereby optimizing performance.

### **Adjusting the Logarithmic Intercept**

Adjust the logarithmic intercept by changing the reference current, IREF. A resistor from REFISET to GND (see Figure 5) adjusts the reference current, according to the following equation:

$$R_{SET} = \frac{V_{REFISET}}{10 \times I_{REF}}$$

where  $V_{REFISET}$  is 0.5V. Select R<sub>SET</sub> between  $5k\Omega$  and  $5M\Omega$ . REFIOUT current range is 10nA to 10 $\mu$ A only.

### **Dual-Supply Operation**

The MAX4207 operates only from dual ±2.7 to ±5.5V supplies. The relationship of inputs to outputs is a function of IREF, relative to ILOG, and the configuration of the uncommitted amplifier. The uncommitted amplifier can be configured in either inverting or noninverting mode. In an inverting configuration, the uncommitted amplifier output, LOGV2, is positive and LOGV1 is negative when I OG exceeds IRFF. When operating in a noninverting configuration, LOGV2 and LOGV1 are both negative when ILOG exceeds IRFF (see Table 1). An inverting configuration of the uncommitted buffer is recommended when large output offset voltage adjustments are required using OSADJ. By connecting CMVOUT and CMVIN, the log and reference amplifier inputs (LOGIIN and REFIIN) are biased at OV. Applying the external voltage (0 to 0.5V) to CMVIN optimizes the application's performance.

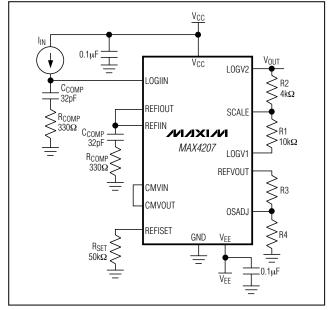


Figure 5. Typical Operating Circuit

Table 1. MAX4207 Example Configurations

LOGV2 AMPLIFIER CONFIGURATION	INPUT CONDITIONS	V <sub>LOGV1</sub>	V <sub>LOGV2</sub>
Investing	ILOG > IREF (constant)	Negative	Positive
Inverting	ILOG < IREF (constant)	Positive	Negative
Nanipuarting	ILOG > IREF (constant)	Negative	Negative
Noninverting	I <sub>LOG</sub> < I <sub>REF</sub> (constant)	Positive	Positive

#### **Output Offset**

The inverting configuration utilized by the MAX4207 facilitates large output-offset voltage adjustments. The magnitude of the offset voltage is given by the following equation:

$$V_{OS} = V_{OSADJ} \left( 1 + \frac{R_2}{R_1} \right)$$

A resistive divider between REFVOUT, OSADJ, and GND can be used to adjust VoSADJ (see Figure 5).

$$V_{OSADJ} = V_{REFOUT} \left( \frac{R_4}{R_3 + R_4} \right)$$

#### Scale Factor

The scale factor, K, is the slope of the logarithmic output. For the LOGV1 amplifier, K = -0.25V/decade. Adjust the overall scale factor for the MAX4207 using the uncommitted LOGV2 amplifier and the following equation, which refers to Figure 5:

$$R_2 = R_1 \left| \frac{K}{-0.25} \right|$$

Select R<sub>2</sub> between  $1k\Omega$  and  $100k\Omega$ .

Design Example

Desired:

Logarithmic intercept: 1µA

Overall scale factor = +1V/decade

$$R_{SET} = \frac{0.5V}{10 \times 1\mu A} = 50k\Omega$$

Select  $R_1 = 10k\Omega$ :

$$R2 = 10k\Omega \times \left| \frac{1V/\text{decade}}{-0.25} \right| = 40k\Omega$$

### **Photodiode Current Monitoring**

Figure 6 shows the MAX4207 in an optical-power measurement circuit, common in fiberoptic applications. The MAX4007 current monitor converts the sensed APD current to an output current that drives the MAX4207 LOGIIN input (APD current is scaled by 0.1). The MAX4007 also buffers the high-voltage APD voltages from the lower MAX4207 voltages. The MAX4207's internal current reference sources 10nA (RSET =  $5M\Omega$ ) to the REFIIN input. This configuration sets the logarithmic intercept to 10nA, corresponding to an APD current of 100nA. The unity-gain configuration of the output buffer maintains the -0.25V/decade gain present at the LOGV1 output.

### **Measuring Optical Absorbance**

A photodiode provides a convenient means of measuring optical power, as diode current is proportional to the incident optical power. Measure absolute optical power using a single photodiode connected at LOGIIN, with the MAX4207's internal current reference driving REFIIN. Alternatively, connect a photodiode to each of the MAX4207's logging inputs, LOGIIN and REFIIN, to measure relative optical power (Figure 7).

In absorbance measurement instrumentation, a reference light source is split into two paths. The unfiltered path is incident upon the photodiode of the reference channel, REFIIN. The other path passes through a sample of interest, with the resulting filtered light incident on the photodiode of the second channel, LOGIIN. The MAX4207 outputs provide voltages proportional to the log ratio of the two optical powers—an indicator of the optical absorbance of the sample.

In wavelength-locking applications, often found in fiberoptic communication modules, two photodiode currents provide a means of determining whether a given optical channel is tuned to the desired optical frequency. In this application, two bandpass optical filters with overlapping "skirts" precede each photodiode. With proper filter selection, the MAX4207 output can vary monotonically (ideally linearly) with optical frequency.

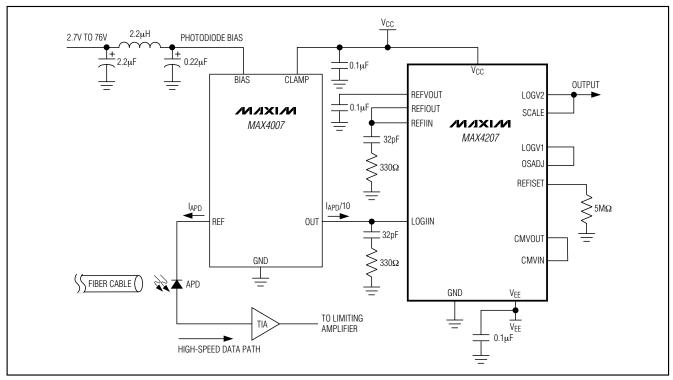


Figure 6. Logarithmic Current-Sensing Amplifier with Sourcing Input

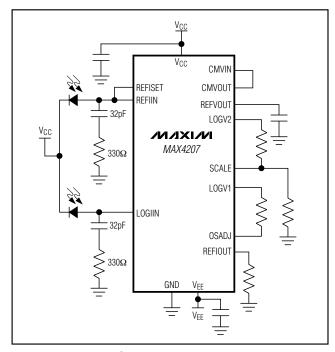


Figure 7. Measuring Optical Absorbance

### **Capacitive Loads**

The MAX4207 drives capacitive loads of up to 50pF. Reactive loads decrease phase margin and can produce excessive ringing and oscillation. Use an isolation resistor in series with LOGV1 or LOGV2 to reduce the effect of large capacitive loads. Recall that the combination of the capacitive load and the small isolation resistor limits AC performance.

#### **Power Dissipation**

The LOGV1 and LOGV2 amplifiers are capable of sourcing or sinking in excess of 30mA. Ensure that the continuous power dissipation rating for the MAX4207 is not exceeded.

#### **TQFN Package**

The 16-lead thin QFN package has an exposed paddle that provides a heat-removal path, as well as excellent electrical grounding to the PC board. The MAX4207's exposed pad is internally connected to VEE, and can either be connected to the PC board VEE plane or left unconnected. Ensure that only VEE traces are routed under the exposed paddle.



### Layout and Bypassing

Bypass V<sub>CC</sub> and V<sub>EE</sub> to GND with ceramic  $0.1\mu F$  capacitors. Place the capacitors as close to the device as possible. Bypass REFVOUT and/or CMVOUT to GND with a  $0.1\mu F$  ceramic capacitor for increased noise immunity and a clean reference current. For low-current operation, it is recommended to use metal guard rings around LOGIIN, REFIIN, and REFISET. Connect this guard ring to CMVOUT.

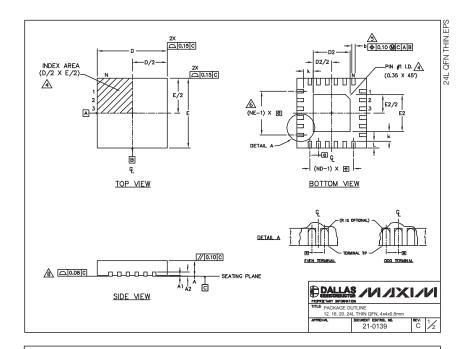
\_Chip Information

TRANSISTOR COUNT: 754
PROCESS: BICMOS

14 \_\_\_\_\_\_ *NIXIN*I

### **Package Information**

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



	COMMON DIMENSIONS											
PKG	12	L 4×	4	16	L 4x	4	20	L 4×	4	24	∮L 4×	:4
REF.	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.	MIN.	NOM.	MAX
A	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80
A1	0.0	20,0	0.05	0.0	0.02	0.05	0.0	20.0	0.05	0.0	0.02	0.05
A2	0.20 REF			0	.20 RE	F	0	20 RE	+	0.20 REF		
ь	0.25	0.30	0.35	0.25	0.30	0.35	0.20	0.25	0.30	0.18	0.23	0.30
D	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10
E	3.90	4.00	4.10	3.90	4.00	410	3.90	4.00	4.10	3.90	4.00	4.10
6		.80 BS	C.	0.65 BSC.		0.50 BSC.		0.50 BSC.				
k	0.25	-	ı	0.25	-	-	0.25	ı	ı	0.25	-	-
L	0.45	0.55	0.65	0.45	0.55	0.65	0.45	0.55	0.65	0.30	0.40	0.50
N	12			16		20		24				
ND	3		4		5		6					
NE	3		4		5		6					
Jedec Var.		WGGB			WGGC		,	/GGD-:	_	WGGD-2		

Ε	XPDS	SED	PAD	VAR	ITAI	BNS	
PKG.		DS			E2		DOWN RONDS
CODES	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.	ALLOVED
T1244-2	1.95	2.10	2.25	1.95	2.10	2.25	ND
T1244-3	1.95	2.10	2,25	1.95	2.10	2,25	YES
T1244-4	1.95	2.10	2.25	1.95	2.10	2.25	ND
T1644-2	1.95	2.10	2,25	1.95	2.10	2.25	ND
T1644-3	1.95	2.10	2.25	1.95	2.10	2.25	YES
T1644-4	1.95	5'10	2.25	1.95	2.10	2.25	ND
T2044-1	1.95	2.10	2.25	1.95	2.10	2.25	ND
T2044-2	1.95	2.10	2.25	1.95	2.10	2,25	YES
T2044-3	1.95	2.10	2.25	1.95	2.10	2.25	ND
T2444-1	2.45	2.60	2.63	2.45	2.60	2.63	ND
T2444-2	1.95	2.10	2.25	1.95	2.10	2.25	YES
T2444-3	2.45	2.60	2.63	2.45	2.60	2.63	YES
T2444-4	2.45	2.60	2.63	2.45	2.60	2.63	ND

- 1. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
- ALL DIMENSIONS ARE IN MILLIMETERS, ANGLES ARE IN DEGREES.

  N IS THE TOTAL NUMBER OF TERMINALS.
- THE TERMINAL #1 IDENTIFIER AND TERMINAL MUMBERING CONVENTION SHALL CONFORM TO JOSS 5-1 SYP-012. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL, BILL MUST BE LICATED WITHIN THE ZONE MICHAELD. THE ERMINAL #1 IDENTIFIER MAY BE ETHER A MULD OF MARKED TEATURE.
- DIMENSION 6 APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25 mm AND 0.30 mm FROM TERMINAL TIP.
- AND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY. DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.
- COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
- WING CONFORMS TO JEDEC MO220, EXCEPT FOR T2444-1, T2444-3 AND T2444-4

PROPRIETARY INFORMAT		(L	
PACKAGE O	UTLINE IL THIN QFN. 4x4x0.8mm		
12, 10, 20, 24	DOCUMENT CONTROL NO.	REV	6 10 4
1	21-0139	0	1/2

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